# 8-Bit Addressable Latch 1-of-8 Decoder with LSTTL Inputs

# High-Performance Silicon-Gate CMOS

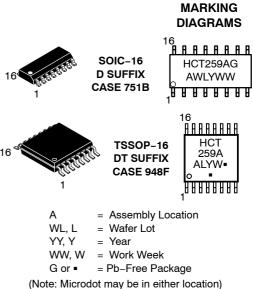
The MC74HCT259A is identical in pinout to the LS259. The device inputs are compatible with standard CMOS and LSTTL outputs.

The HCT259A has four modes of operation as shown in the mode selection table. In the addressable latch mode, the data on Data In is written into the addressed latch. The addressed latch follows the data input with all non-addressed latches remaining in their previous states. In the memory mode, all latches remain in their previous state and are unaffected by the Data or Address inputs. In the one-of-eight decoding or demultiplexing mode, the addressed output follows the state of Data In with all other outputs in the LOW state. In the Reset mode all outputs are LOW and unaffected by the address and data inputs. When operating the HCT259A as an addressable latch, changing more than one bit of the address could impose a transient wrong address. Therefore, this should only be done while in the memory mode.

#### Features

- Output Drive Capability: 10 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 4.5 to 5.5 V
- Low Input Current: 1 μA
- High Noise Immunity Characteristic of CMOS Devices
- These are Pb–Free Devices





PIN	PIN ASSIGNMENT					
A0	ď	1•	16	v <sub>cc</sub>		
A1	d.	2	15	] RESET		
A2	d	3	14	] ENABLE		
Q0	d.	4	13	DATA IN		
Q1	d.	5	12	] Q7		
Q2	þ	6	11	] Q6		
Q3	þ	7	10	] Q5		
GND	þ	8	9	] Q4		
	-					

#### MODE SELECTION TABLE

Enable	Reset	Mode
L	Н	Addressable Latch
н	Н	Memory
L	L	8-Line Demultiplexer
н	L	Reset

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

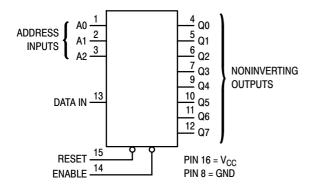


Figure 1. Logic Diagram

### MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	DC Supply Voltage (Referenced to GND)	-0.5 to +7.0	V
V <sub>in</sub>	DC Input Voltage (Referenced to GND)	–0.5 to V <sub>CC</sub> + 0.5	V
V <sub>out</sub>	DC Output Voltage (Referenced to GND)	–0.5 to V <sub>CC</sub> + 0.5	V
l <sub>in</sub>	DC Input Current, per Pin	±20	mA
I <sub>out</sub>	DC Output Current, per Pin	±25	mA
I <sub>CC</sub>	DC Supply Current, $V_{CC}$ and GND Pins	±50	mA
P <sub>D</sub>	Power Dissipation in Still Air, SOIC Package TSSOP Package	500 450	mW
T <sub>stg</sub>	Storage Temperature	-65 to + 150	°C
V <sub>ESD</sub>	ESD Withstand Voltage Human Body Model (Note 1) Machine Model (Note 2)	>2000 >200	V
I <sub>Latchup</sub>	Latchup Performance Above $V_{DD}$ and Below GND at 125°C (Note 3)	±100	mA

LATCH SELECTION TABLE

Ad	dress Inp	uts	
С	В	Α	Latch Addressed
			Q0 Q1 Q2 Q3 Q4 Q5 Q6 Q7

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range GND  $\leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$ .

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or  $V_{CC}$ ). Unused outputs must be left open.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Tested to EIA / JESD22-A114-A.

2. Tested to EIA / JESD22-A115-A.

3. Tested to EIA / JESD78.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter		Max	Unit
V <sub>CC</sub>	DC Supply Voltage (Referenced to GND)	4.5	5.5	V
V <sub>in</sub> , V <sub>out</sub>	DC Input Voltage, Output Voltage (Referenced to GND)	0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature, All Package Types	-55	+125	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Time (Figure 2)	0	500	ns

				Gu	aranteed Li	mit	
Symbol	Parameter	Test Conditions	v <sub>cc</sub> v	- 55 to 25°C	≤ 85°C	≤ 125°C	Unit
V <sub>IH</sub>	Minimum High-Level Input Voltage	$\begin{array}{l} V_{out} = 0.1 \ V \ or \ V_{CC} - 0.1 \ V \\ \left I_{out}\right  \ \leq \ 20 \ \mu A \end{array} \label{eq:V_cc}$	4.5 5.5	2.0 2.0	2.0 2.0	2.0 2.0	V
V <sub>IL</sub>	Maximum Low-Level Input Voltage	$\begin{array}{l} V_{out} = 0.1 \ V \ or \ V_{CC} - 0.1 \ V \\ \left I_{out}\right  \ \leq \ 20 \ \mu A \end{array} \label{eq:V_cc}$	4.5 5.5	0.8 0.8	0.8 0.8	0.8 0.8	V
V <sub>OH</sub>	Minimum High-Level Output Voltage	$ \begin{aligned} V_{in} &= V_{IH} \text{ or } V_{IL} \\  I_{out}  &\leq 20 \; \mu A \end{aligned} $	4.5 5.5	4.4 5.4	4.4 5.4	4.4 5.4	V
		$V_{in} = V_{IH} \text{ or } V_{IL} $ $ I_{out}  \le 5.2 \text{ mA}$	4.5	3.98	3.84	3.70	
V <sub>OL</sub>	Maximum Low-Level Output Voltage	$ \begin{aligned} V_{in} &= V_{IH} \text{ or } V_{IL} \\  I_{out}  &\leq 20 \ \mu A \end{aligned} $	4.5 5.5	0.1 0.1	0.1 0.1	0.1 0.1	V
		$V_{in} = V_{IH} \text{ or } V_{IL} $ $ I_{out}  \le 5.2 \text{ mA}$	4.5	0.26	0.33	0.40	
l <sub>in</sub>	Maximum Input Leakage Current	V <sub>in</sub> = V <sub>CC</sub> or GND	5.5	±0.1	± 1.0	± 1.0	μA
I <sub>CC</sub>	Maximum Quiescent Supply Current (per Package)	$V_{in} = V_{CC} \text{ or GND}$ $I_{out} = 0 \ \mu A$	5.5	4	40	160	μA
$\Delta I_{CC}$	Additional Quiescent Supply Current	$V_{in}$ = 2.4V, Any One Input $V_{in}$ = V <sub>CC</sub> or GND, Other Inputs		≥ <b>-55°C</b>	25 to	125°C	
	ounon	$I_{out} = 0\mu A$	5.5	2.9	2	.4	mA

### DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

## AC ELECTRICAL CHARACTERISTICS (V<sub>CC</sub> = 4.5 to 5.5 V, C<sub>L</sub> = 50 pF, Input t<sub>f</sub> = t<sub>f</sub> = 6 ns)

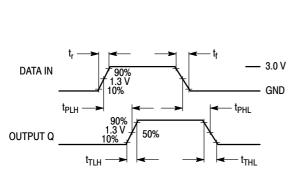
		Gu	Guaranteed Limit		
Symbol	Parameter	–55 to 25°C	≤ 85°C	≤ 125°C	Unit
t <sub>PLH</sub> , t <sub>PHL</sub>	Maximum Propagation Delay, Data to Output (Figures 2 and 7)	32	32	42	ns
t <sub>PLH</sub> , t <sub>PHL</sub>	Maximum Propagation Delay, Address Select to Output (Figures 3 and 7)	32	40	45	ns
t <sub>PLH</sub> , t <sub>PHL</sub>	Maximum Propagation Delay, Enable to Output (Figures 4 and 7)	32	40	45	ns
t <sub>PHL</sub>	Maximum Propagation Delay, Reset to Output (Figures 5 and 7)	22	26	32	ns
t <sub>TLH</sub> , t <sub>THL</sub>	Maximum Output Transition Time, Any Output (Figures 2 and 7)	15	19	22	ns
C <sub>in</sub>	Maximum Input Capacitance	10	10	10	pF

		Typical @ 25°C, $V_{CC}$ = 5.0 V	
C <sub>PD</sub>	Power Dissipation Capacitance (Per Package)	30	pF

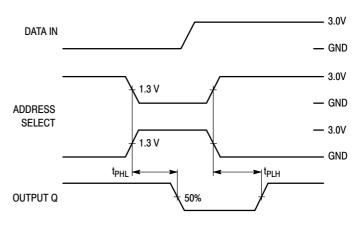
## TIMING REQUIREMENTS (V\_{CC} = 4.5 to 5.5 V, Input $t_{r}$ = $t_{f}$ = 6 ns)

		Guaranteed Limit			
Symbol	Parameter	–55 to 25°C	≤ 85°C	≤ 125°C	Unit
t <sub>su</sub>	Minimum Setup Time, Address or Data to Enable (Figure 6)	15	19	22	ns
t <sub>h</sub>	Minimum Hold Time, Enable to Address or Data (Figure 6)	1	1	1	ns
t <sub>w</sub>	Minimum Pulse Width, Reset or Enable (Figure 4 or 5)	15	19	22	ns

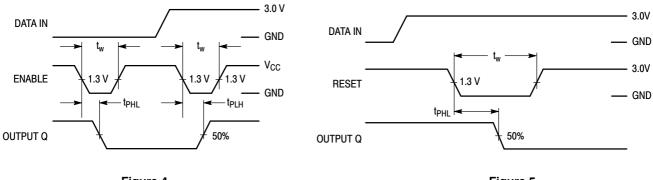
## SWITCHING WAVEFORMS





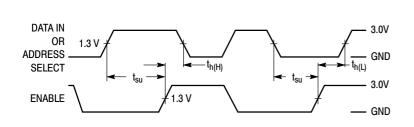


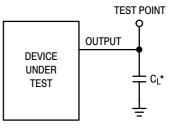








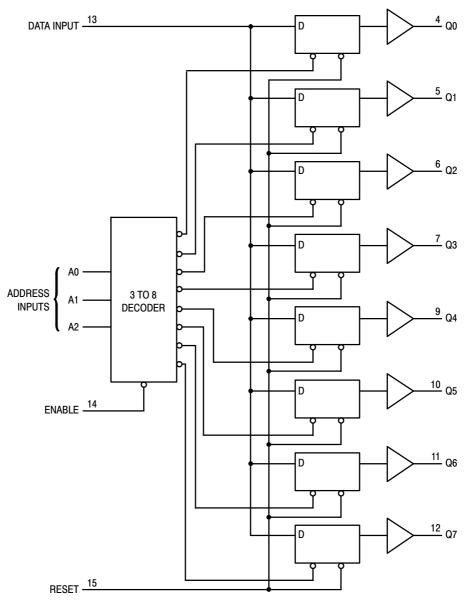


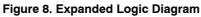


\*Includes all probe and jig capacitance

Figure 7. Test Circuit

Figure 6.





### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MC74HCT259ADG	SOIC-16 (Pb-Free)	48 Units / Rail
MC74HCT259ADR2G	SOIC-16 (Pb-Free)	2500 Tape & Reel
MC74HCT259ADTR2G	TSSOP-16*	2500 Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
\*This package is inherently Pb-Free.



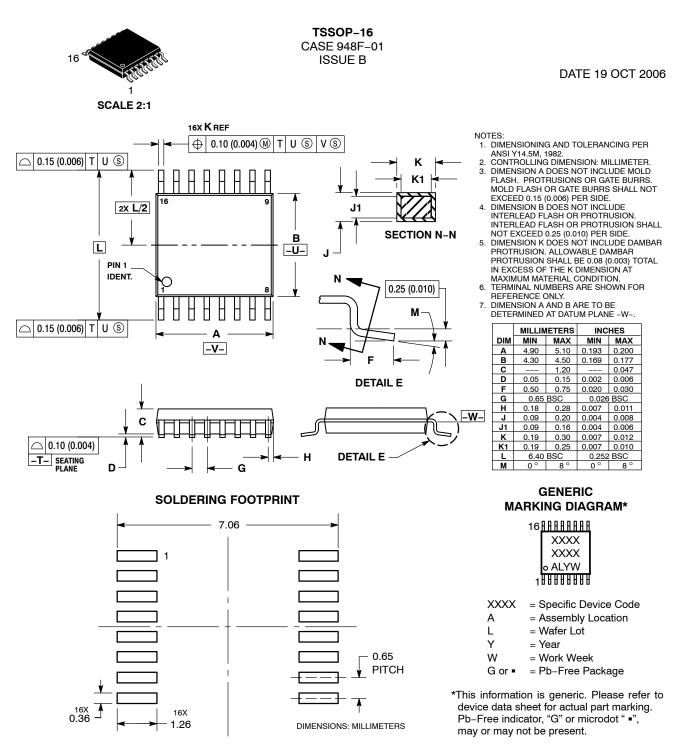


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